

IR Receiver Modules for Remote Control Systems



16797

MECHANICAL DATA

Pinning

 1 = GND, 2 = N.C., 3 = V_S , 4 = OUT

ORDERING CODE

Taping:

TSOP6...TT - top view taped

TSOP6...TR - side view taped

FEATURES

- Low supply current
- Photo detector and preamplifier in one package
- Internal filter for PCM frequency
- Improved shielding against EMI
- Supply voltage: 2.5 V to 5.5 V
- Improved immunity against ambient light
- Insensitive to supply voltage ripple and noise
- Taping available for top view and side view assembly
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912



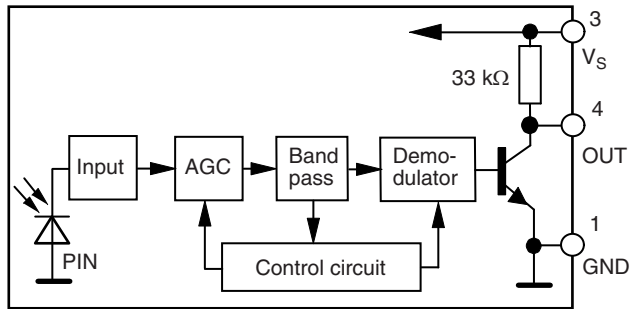
DESCRIPTION

The TSOP61.., TSOP63.. series are miniaturized SMD-IR receivers for infrared remote control systems. A PIN diode and a preamplifier are assembled on a lead frame, the epoxy package acts as an IR filter.

The demodulated output signal can be directly connected to a microprocessor for decoding. The TSOP61.. is a legacy product compatible with all common IR remote control data formats. The TSOP63.. is optimized to better suppress spurious pulses from energy saving fluorescent lamps. The TSOP65.. has an excellent noise suppression. It is immune to dimmed LCD backlighting and any fluorescent lamps. AGC3 and AGC5 may also suppress some data signals in case of continuous transmission. Between these three receiver types, the TSOP63.. is preferred. Customers should initially try the TSOP63.. in their design.

This component has not been qualified according to automotive specifications.

PARTS TABLE				
AGC		LEGACY, FOR SHORT BURST REMOTE CONTROLS (AGC1)	NOISY ENVIRONMENTS AND SHORT BURSTS (AGC3)	VERY NOISY ENVIRONMENTS AND SHORT BURSTS (AGC5)
Carrier frequency	30 kHz	TSOP6130	TSOP6330	TSOP6530
	33 kHz	TSOP6133	TSOP6333	TSOP6533
	36 kHz	TSOP6136	TSOP6336 ⁽¹⁾⁽²⁾	TSOP6536 ⁽¹⁾⁽²⁾
	38 kHz	TSOP6138	TSOP6338 ⁽³⁾⁽⁴⁾⁽⁵⁾⁽⁶⁾	TSOP6538 ⁽³⁾⁽⁴⁾⁽⁵⁾
	40 kHz	TSOP6140	TSOP6340	TSOP6540
	56 kHz	TSOP6156	TSOP6356	TSOP6556
Package	Panhead			
Pinning	1 = GND, 2 = N.C., 3 = V_S , 4 = OUT			
Dimensions (mm)	7.5 W x 5.3 H x 4.0 D			
Mounting	SMD			
Application	Remote control			
Best remote control code	⁽¹⁾ MCIR ⁽²⁾ RCMM ⁽³⁾ Mitsubishi ⁽⁴⁾ RECS-80 Code ⁽⁵⁾ r-map ⁽⁶⁾ XMP-1, XMP-2			

BLOCK DIAGRAM


16838-1

APPLICATION CIRCUIT


The external components R_1 and C_1 are optional to improve the robustness against electrical overstress (typical values are $R_1 = 100 \Omega$, $C_1 = 0.1 \mu\text{F}$).

ABSOLUTE MAXIMUM RATINGS

PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Supply voltage		V_S	-0.3 to +6	V
Supply current		I_S	5	mA
Output voltage		V_O	-0.3 to ($V_S + 0.3$)	V
Output current		I_O	5	mA
Junction temperature		T_j	100	°C
Storage temperature range		T_{stg}	-25 to +85	°C
Operating temperature range		T_{amb}	-25 to +85	°C
Power consumption	$T_{\text{amb}} \leq 85 \text{ }^\circ\text{C}$	P_{tot}	10	mW

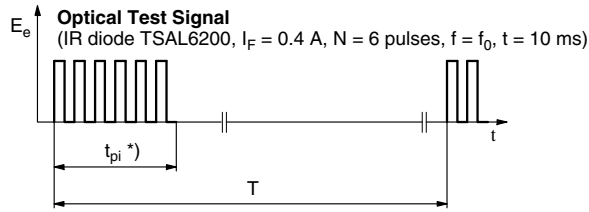
Note

- Stresses beyond those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect the device reliability.

ELECTRICAL AND OPTICAL CHARACTERISTICS ($T_{\text{amb}} = 25 \text{ }^\circ\text{C}$, unless otherwise specified)

PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply voltage		V_S	2.5		5.5	V
Supply current	$V_S = 5 \text{ V}$, $E_v = 0$	I_{SD}	0.55	0.7	0.9	mA
	$E_v = 40 \text{ klx}$, sunlight	I_{SH}		0.8		mA
Transmission distance	$E_v = 0$, IR diode TSAL6200, $I_F = 250 \text{ mA}$, test signal see fig. 1	d		40		m
Output voltage low	$I_{\text{OSL}} = 0.5 \text{ mA}$, $E_e = 0.7 \text{ mW/m}^2$, test signal see fig. 1	V_{OSL}			100	mV
Minimum irradiance	Pulse width tolerance: $t_{\text{pi}} - 5/f_o < t_{\text{po}} < t_{\text{pi}} + 6/f_o$, test signal see fig. 1	$E_e \text{ min.}$		0.2	0.4	mW/m^2
Maximum irradiance	$t_{\text{pi}} - 5/f_o < t_{\text{po}} < t_{\text{pi}} + 6/f_o$, test signal see fig. 1	$E_e \text{ max.}$	50			W/m^2
Directivity	Angle of half transmission distance	$\phi_{1/2}$		± 50		deg

TYPICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)



*) $t_{pi} \geq 6/f_0$ is recommended for optimal function

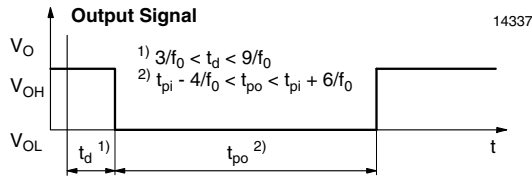


Fig. 1 - Output Active Low

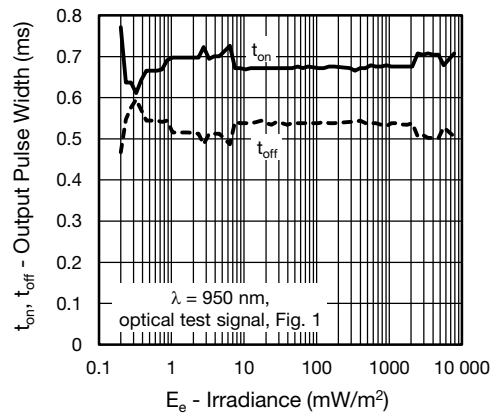


Fig. 4 - Output Pulse Diagram

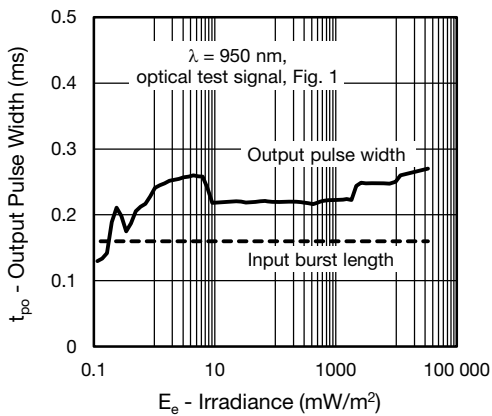


Fig. 2 - Pulse Length and Sensitivity in Dark Ambient

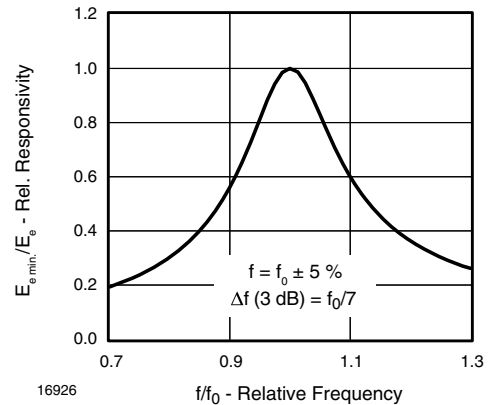


Fig. 5 - Frequency Dependence of Responsivity

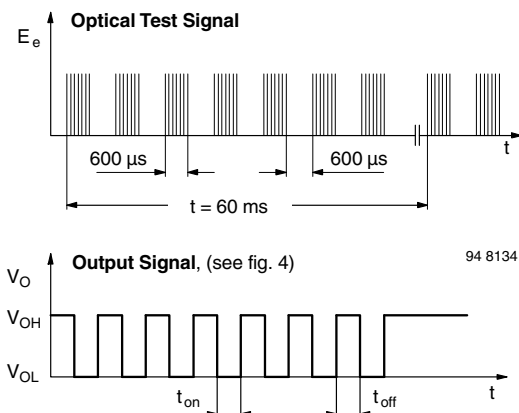


Fig. 3 - Output Function

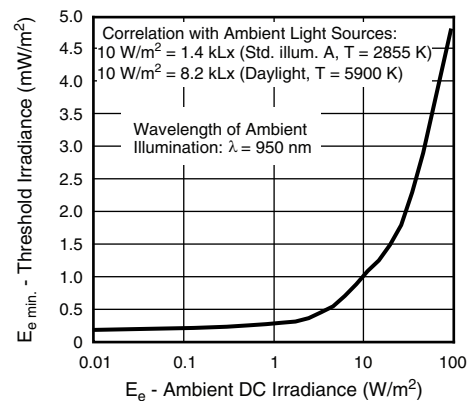


Fig. 6 - Sensitivity in Bright Ambient

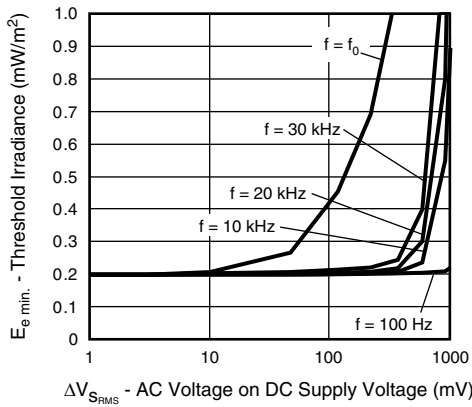


Fig. 7 - Sensitivity vs. Supply Voltage Disturbances

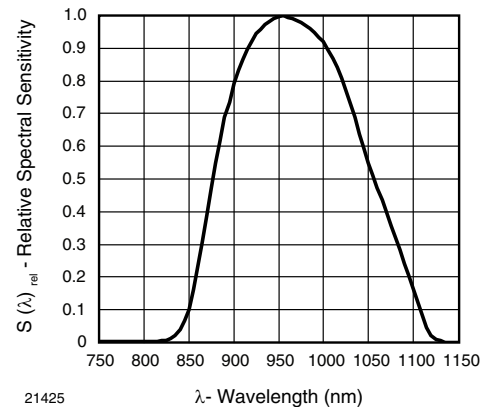


Fig. 10 - Relative Spectral Sensitivity vs. Wavelength

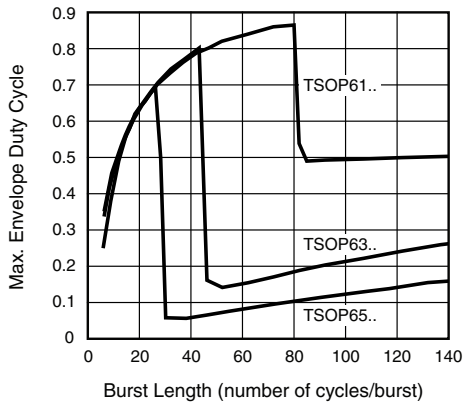


Fig. 8 - Max. Envelope Duty Cycle vs. Burst Length



Fig. 11 - Horizontal Directivity

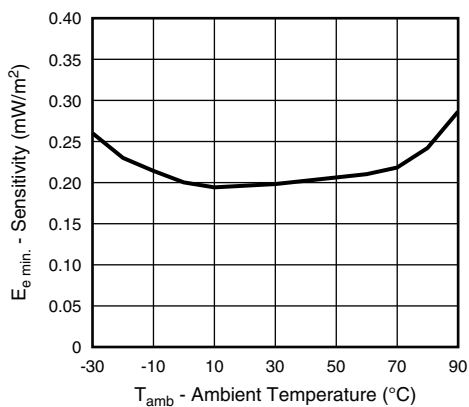


Fig. 9 - Sensitivity vs. Ambient Temperature

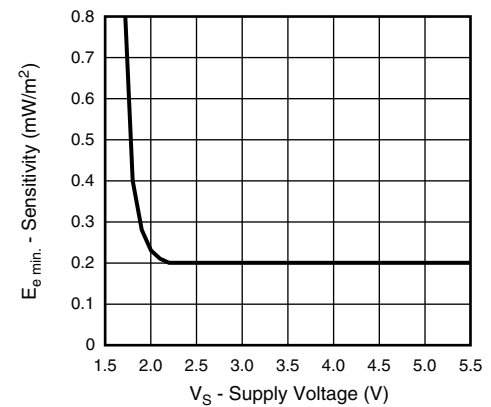


Fig. 12 - Sensitivity vs. Supply Voltage

SUITABLE DATA FORMAT

This series is designed to suppress spurious output pulses due to noise or disturbance signals. The devices can distinguish data signals from noise due to differences in frequency, burst length, and envelope duty cycle. The data signal should be close to the device's band-pass center frequency (e.g. 38 kHz) and fulfill the conditions in the table below.

When a data signal is applied to the product in the presence of a disturbance, the sensitivity of the receiver is automatically reduced by the AGC to insure that no spurious pulses are present at the receiver's output.

Some examples which are suppressed are:

- DC light (e.g. from tungsten bulbs sunlight)
- Continuous signals at any frequency
- Strongly or weakly modulated patterns from fluorescent lamps with electronic ballasts (see figure 13 or figure 14)



Fig. 13 - IR Disturbance from Fluorescent Lamp with Low Modulation

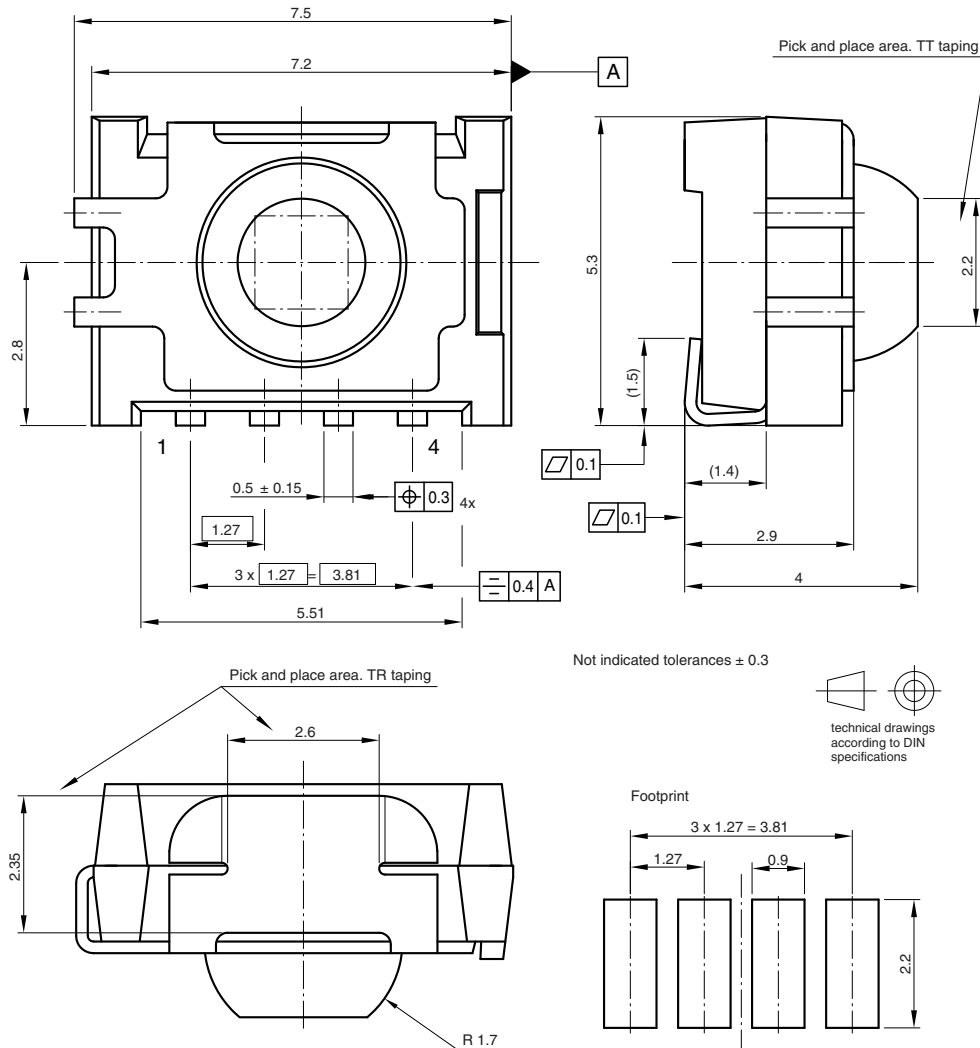


Fig. 14 - IR Disturbance from Fluorescent Lamp with High Modulation

	TSOP61..	TSOP63..	TSOP65..
Minimum burst length	6 cycles/burst	6 cycles/burst	6 cycles/burst
After each burst of length A gap time is required of	6 to 70 cycles ≥ 10 cycles	6 to 35 cycles ≥ 10 cycles	6 to 24 cycles ≥ 10 cycles
For bursts greater than a minimum gap time in the data stream is needed of	70 cycles > 1.2 x burst length	35 cycles > 6 x burst length	24 cycles > 25 ms
Maximum number of continuous short bursts/second	2000	2000	2000
MCIR code	yes	preferred	yes
RCMM code	yes	preferred	yes
XMP-1, XMP-2 code	yes	preferred	yes
Suppression of interference from fluorescent lamps	Common disturbance patterns are suppressed (example: signal pattern of fig. 14)	Even critical disturbance patterns are suppressed (examples: signal pattern of fig. 14 and fig. 15)	Even critical disturbance patterns are suppressed (examples: signal pattern of fig. 14 and fig. 15)

Notes

- For data formats with long bursts (more than 10 carrier cycles) please see the datasheet for TSOP62.., TSOP64..
- Best choice of AGC for some popular IR-codes:
 - TSOP6336, TSOP36536: MCIR, RCMM
 - TSOP6538: Mitsubishi, RECS-80 Code
 - TSOP6338: XMP-1, XMP-2, r-map
- For SIRCS 15 and 20 bit, Sony 12 bit IR-codes, please see the datasheet for TSOP4S40, TSOP2S40

PACKAGE DIMENSIONS in millimeters


Drawing-No.: 6.544-5341.01-4
 Issue: 8; 02.09.09
 16776

ASSEMBLY INSTRUCTIONS
Reflow Soldering

- Reflow soldering must be done within 72 h while stored under a max. temperature of 30 °C, 60 % RH after opening the dry pack envelope
- Set the furnace temperatures for pre-heating and heating in accordance with the reflow temperature profile as shown in the diagram. Exercise extreme care to keep the maximum temperature below 260 °C. The temperature shown in the profile means the temperature at the device surface. Since there is a temperature difference between the component and the circuit board, it should be verified that the temperature of the device is accurately being measured
- Handling after reflow should be done only after the work surface has been cooled off

Manual Soldering

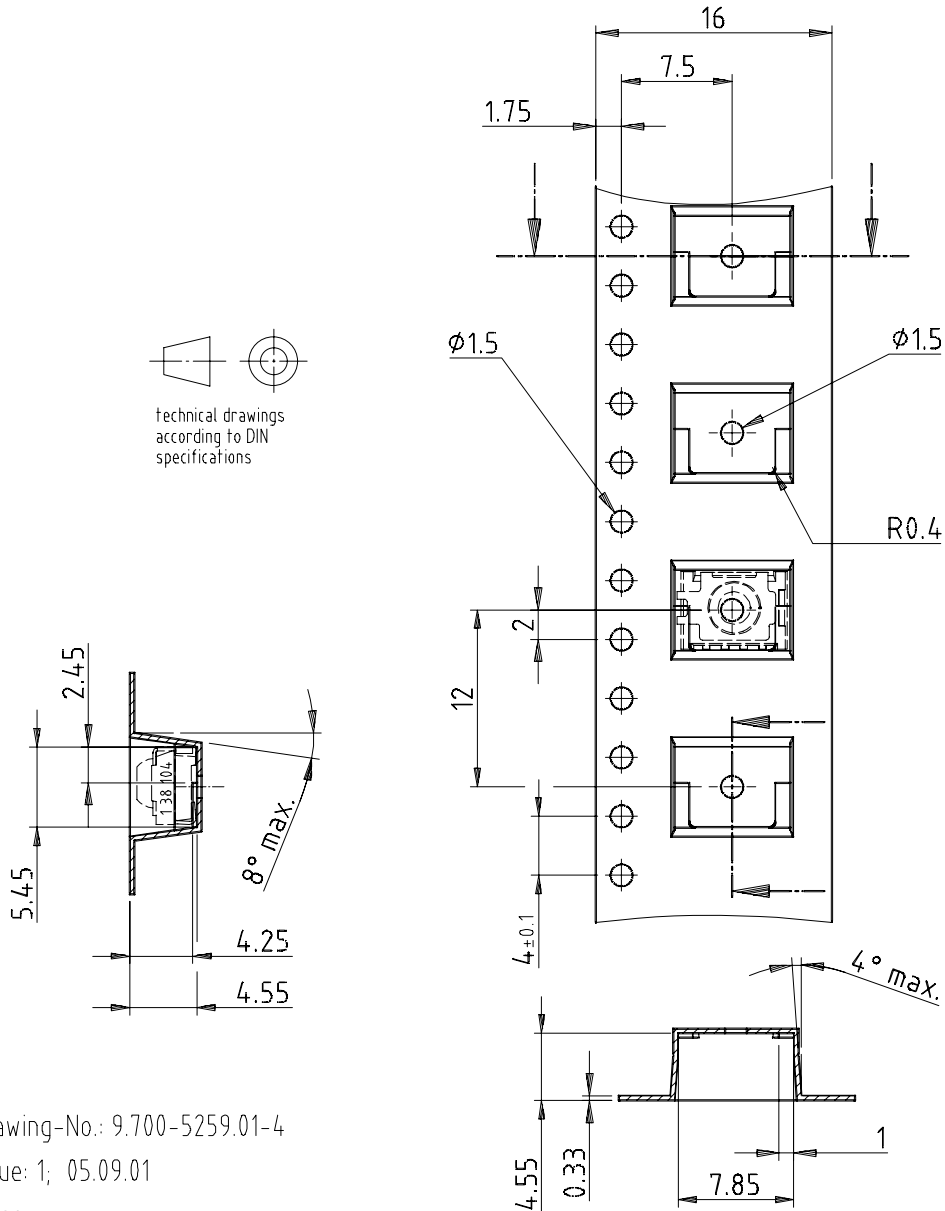
- Use a soldering iron of 25 W or less. Adjust the temperature of the soldering iron below 300 °C
- Finish soldering within 3 s
- Handle products only after the temperature has cooled off



VISHAY LEAD (Pb)-FREE REFLOW SOLDER PROFILE

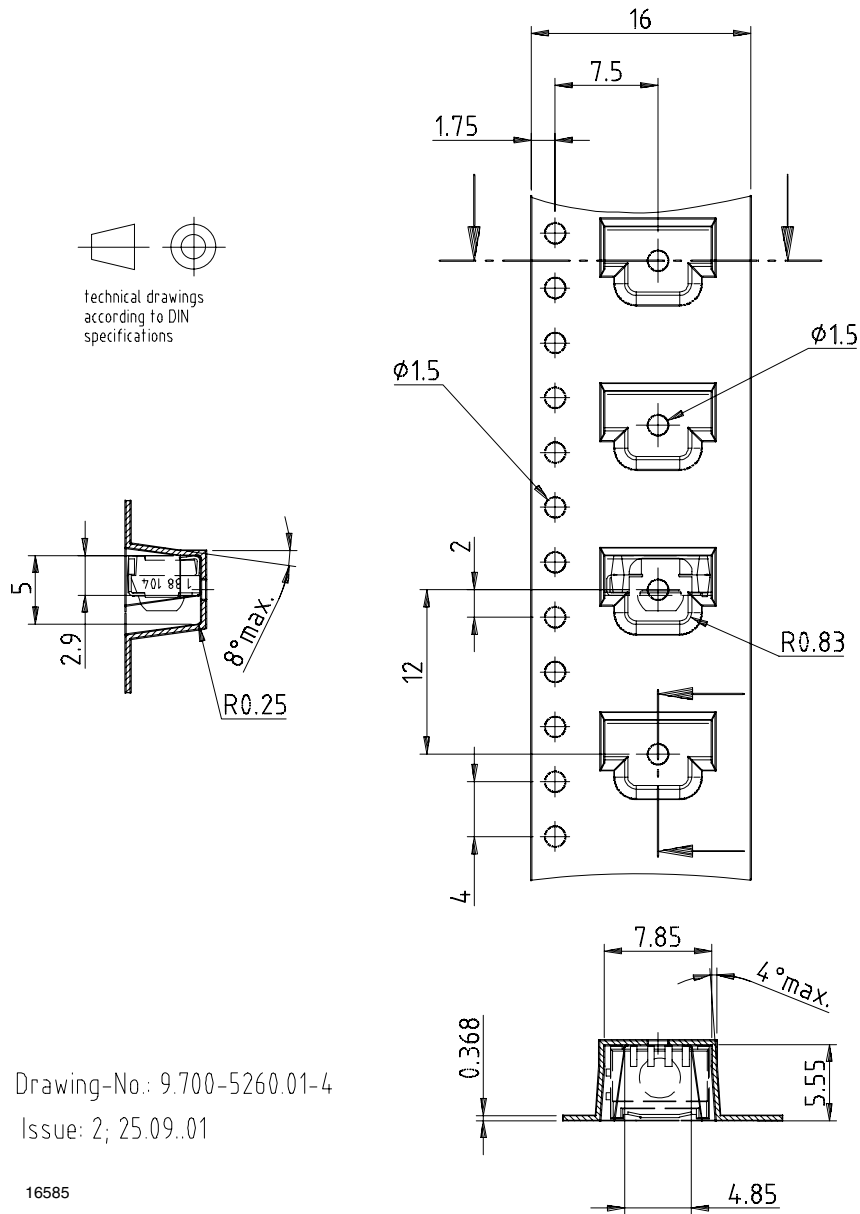


TAPING VERSION TSOP..TT DIMENSIONS in millimeters





TAPING VERSION TSOP..TR DIMENSIONS in millimeters



Drawing-No.: 9.700-5260.01-4

Issue: 2; 25.09..01

16585



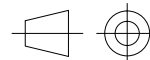
REEL DIMENSIONS in millimeters



Form of the leave open of the wheel is supplier specific.

Dimension acc. to IEC EN 60 286-3

Tape width 16



technical drawings according to DIN specifications

Drawing-No.: 9.800-5052.V2-4

Issue: 1; 07.05.02

16734

LEADER AND TRAILER DIMENSIONS in millimeters



COVER TAPE PEEL STRENGTH

According to DIN EN 60286-3

0.1 N to 1.3 N

300 ± 10 mm/min.

165° to 180° peel angle

LABEL

Standard bar code labels for finished goods

The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.

VISHAY SEMICONDUCTOR GmbH STANDARD BAR CODE PRODUCT LABEL (Finished goods)		
PLAIN WRITING	ABBREVIATION	LENGTH
Item-description	-	18
Item-number	INO	8
Selection-code	SEL	3
LOT-/serial-number	BATCH	10
Data-code	COD	3 (YWW)
Plant-code	PTC	2
Quantity	QTY	8
Accepted by	ACC	-
Packed by	PCK	-
Mixed code indicator	MIXED CODE	-
Origin	xxxxxxx+	Company logo
LONG BAR CODE TOP	TYPE	LENGTH
Item-number	N	8
Plant-code	N	2
Sequence-number	X	3
Quantity	N	8
Total length	-	21
SHORT BAR CODE BOTTOM	TYPE	LENGTH
Selection-code	X	3
Data-code	N	3
Batch-number	X	10
Filter	-	1
Total length	-	17

DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



FINAL PACKING

The sealed reel is packed into a cardboard box. A secondary cardboard box is used for shipping purposes.

RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 72 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:
 192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air/nitrogen) or
 96 h at 60 °C + 5 °C and < 5 % RH for all device containers or
 24 h at 125 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC® standard J-STD-020 level 4 label is included on all dry bags.



EIA JEDEC standard J-STD-020 level 4 label is included on all dry bags



ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.



22645



Tape and Reel Standards for SMD IR Receiver Modules

Vishay Semiconductor SMD IR Receivers are packaged on tape and reel. The following specification is based on IEC publication 286, which takes the industrial requirements for automatic insertion into account.

Absolute maximum ratings, mechanical dimensions, optical and electrical characteristics for taped devices are identical to the basic catalog types and can be found in the specifications for untaped devices.

PACKAGING

The tapes of components are available on reels. Each reel is marked with labels which contain the following information:

- Vishay
- Type
- Group
- Tape code, normally part of type name
- Production code
- Quantity

MISSING COMPONENTS

Up to 3 consecutive components may be missing if the gap is followed by at least 6 components. A maximum of 0.5 % of the components per reel quantity may be missing. At least 5 empty positions are present at the start and the end of the tape to enable tape insertion.

Tensile strength of the tape: > 15 N

NUMBER OF COMPONENTS

- A. Panhead SMD: quantity per reel:
 - TT, SMD top view package, 1190 pcs
 - TR, SMD side view package, 1120 pcs
- B. Heimdall: quantity per reel:
 - TT, Heimdall top view package, 2200 pcs
 - TR, Heimdall side view package, 2300 pcs
- C. Heimdall without lens: quantity per reel:
 - WTT, top view package, 2200 pcs
 - WTR, side view package, 2300 pcs
- D. Bugeye: quantity per reel:
 - TT, 2500 pcs
 - TR, 2500 pcs
- E. AP5: quantity per reel:
 - TT, 2500 pcs
 - TR, not available in side view
- F. Belobog: quantity per reel:
 - TT1, 1800 pcs
 - TT2, 7000 pcs
 - TR, not available in side view
- G. Belobog with shield: quantity per reel:
 - TT1, 1500 pcs
 - TT2, 5000 pcs

ORDER DESIGNATION

The type designation of the device is extended by TT or TT1 for top view or TR for side view.

Example:

- TSOP6238TR (reel packing)
- TSOP75238TR (reel packing)
- TSOP75338WTT (reel packing)
- TSOP85438TT (reel packing)
- TSOP85238AP5TR (reel packing)
- TSOP57438TT1 (reel packing)
- TSOP57238HTT1 (reel packing)



REEL DIMENSIONS FOR PANHEAD SMD AND HEIMDALL in millimeters



Form of the leave open of the wheel is supplier specific.

Dimension acc. to IEC EN 60 286-3

Tape width 16



technical drawings according to DIN specifications

Drawing-No.: 9.800-5052.V2-4

Issue: 1; 07.05.02

16734

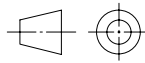
Note

- The body structure of the reel can vary

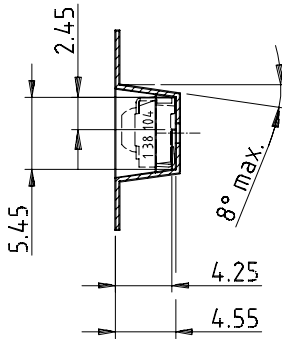


TAPING VERSION TSOP..TT (TOP VIEW) DIMENSIONS in millimeters

A. Panhead SMD (TSOP36...TT, TSOP35...TT, TSOP6...TT)



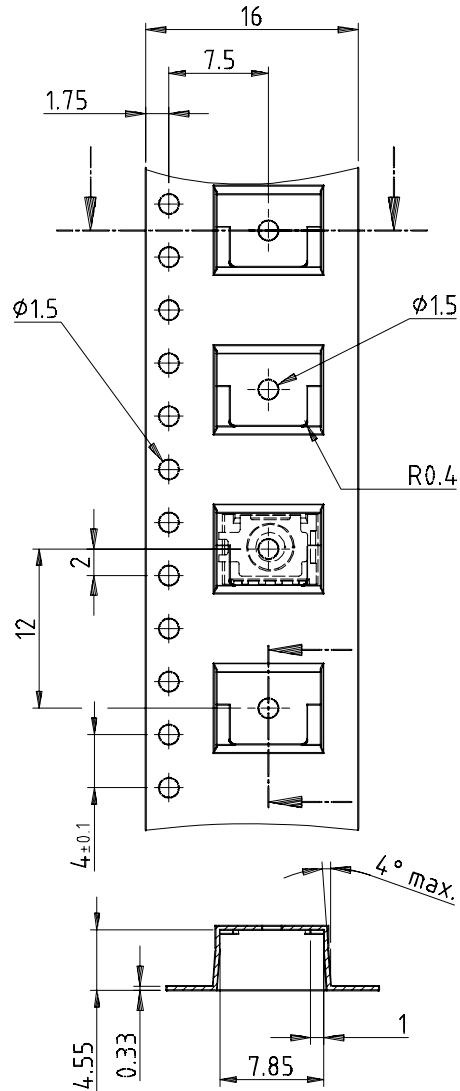
technical drawings according to DIN specifications



Drawing-No.: 9.700-5259.01-4

Issue: 1; 05.09.01

16584





TAPING VERSION TSOP..TT (TOP VIEW) DIMENSIONS in millimeters

B. Heimdall SMD (TSOP75...TT, TSOP77...TT)



Drawing-No.: 9.700-5338.01-4
Issue: 3; 09.06.09
21578

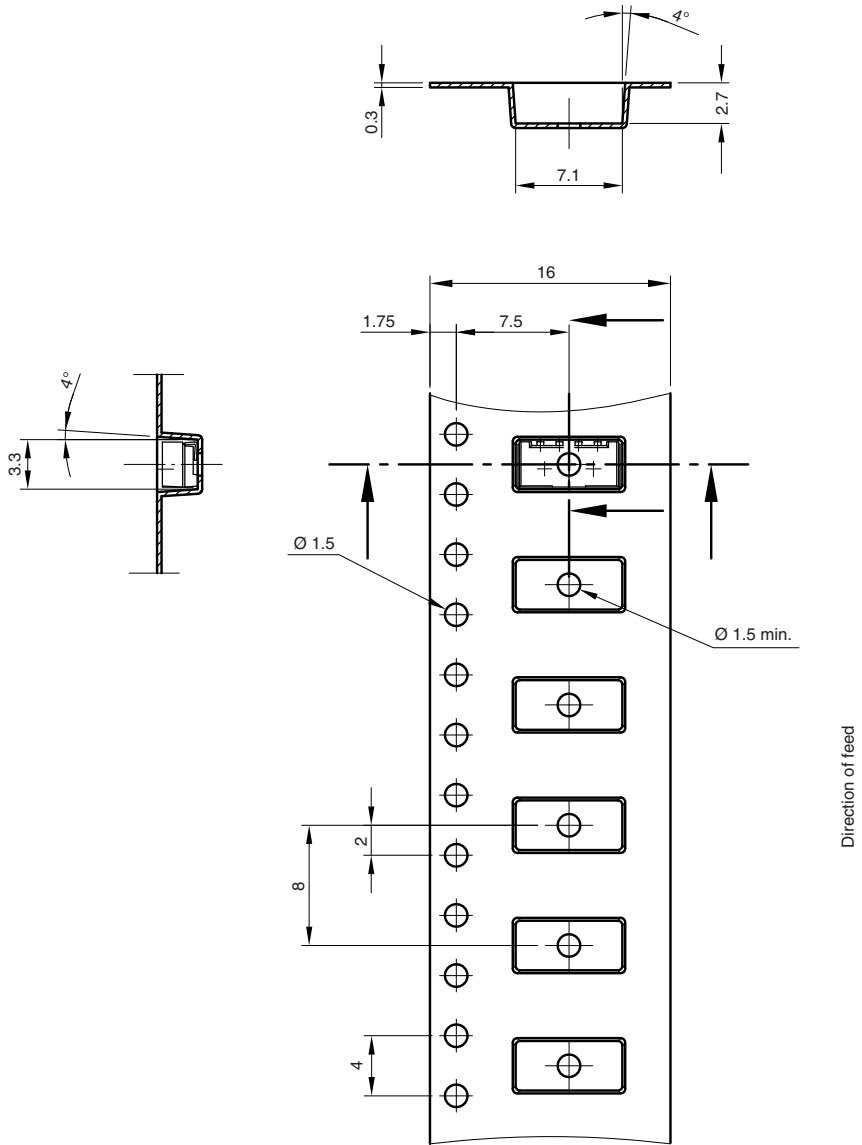


technical drawings
according to DIN
specifications



TAPING VERSION TSOP..TT (TOP VIEW) DIMENSIONS in millimeters

C. Heimdall SMD without lens (TSOP75...WTT, TSOP77...WTT)



Drawing-No.: 9.700-5341.01-4
Issue: 2: 23.03.09
21666



TAPING VERSION TSOP..TT (TOP VIEW) DIMENSIONS in millimeters

E. AP5 (TSOP85...AP5TT)



Drawing-No.: 9.700-5346.01-4
Issue: 2, 24.11.09
21945

TAPING VERSION TSOP..TT1, TSOP..TT2 (TOP VIEW) DIMENSIONS in millimeters

F. Belobog (TSOP37...TT1, TSOP37...TT2, TSOP57...TT1, TSOP57...TT2)



Drawing-No.: 9.700-5347.01-4
 Issue: 1; 14.11.11

Not indicated tolerances ± 0.1



TAPING VERSION TSOP..TT1, TSOP..TT2 (TOP VIEW) DIMENSIONS in millimeters

G. Belobog with shield (TSOP37...HTT1, TSOP37...HTT2, TSOP57...HTT1, TSOP57...HTT2)

Tape and Reel dimensions:



Reel dimensions and tape

Drawing-No.: 9.700-5380.01-4
Issue: 1; 28.10.13



TAPING VERSION TSOP..TR (SIDE VIEW) DIMENSIONS in millimeters

A. Panhead SMD (TSOP36...TR, TSOP35...TR, TSOP6...TR)



Drawing-No.: 9.700-5260.01-4

Issue: 2; 25.09..01

16585



TAPING VERSION TSOP..TR (SIDE VIEW) DIMENSIONS in millimeters

B. Heimdall SMD (TSOP75..., TSOP77...)



Drawing-No.: 9.700-5337.01-4
Issue: 1; 16.10.08
21577



TAPING VERSION TSOP..TR (SIDE VIEW) DIMENSIONS in millimeters

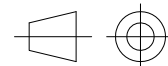
C. Heimdall SMD without lens (TSOP75...WTR, TSOP77...WTR)



Drawing-No.: 9.700-5342.01-4

Issue: 1: 23.03.09

21785

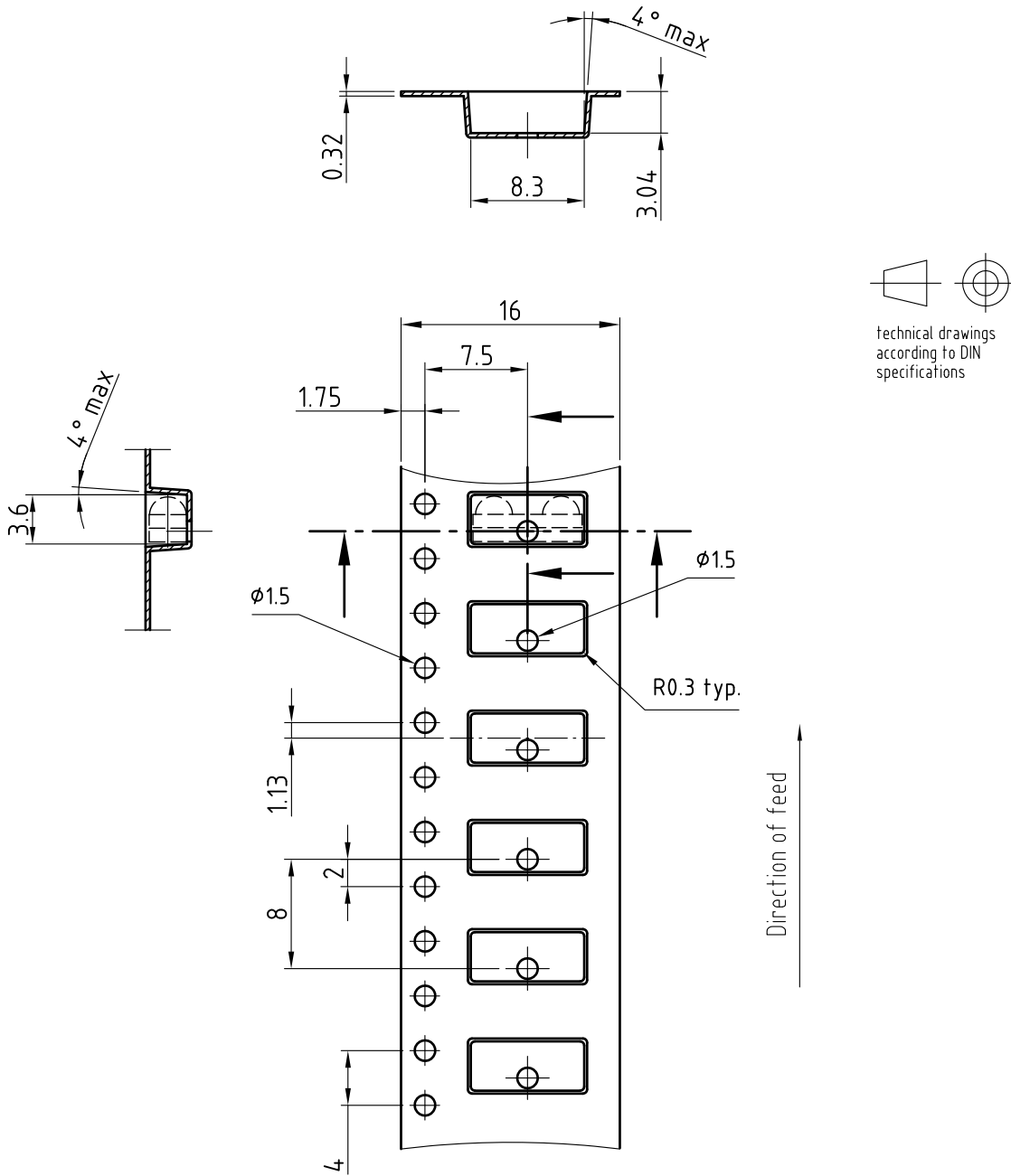


technical drawings
according to DIN
specifications



TAPING VERSION TSOP..TR (SIDE VIEW) DIMENSIONS in millimeters

D. Bugeye (TSOP85...TR)



Drawing-No.: 9.700-5316.01-4

Issue: 1; 12.02.07

20628

LEADER AND TRAILER DIMENSIONS in millimeters



COVER TAPE REEL STRENGTH

According to DIN EN 60286-3

0.1 N to 1.3 N

300 mm/min. \pm 10 mm/min.

165° to 180° peel angle

LABEL

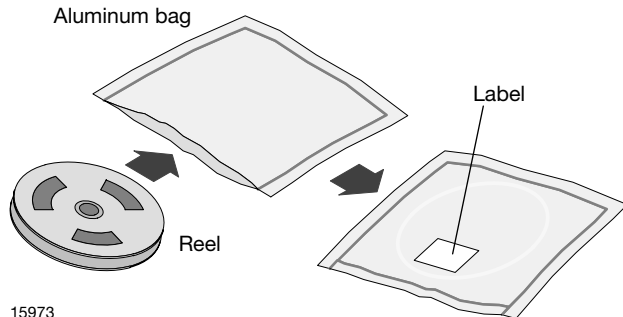
Standard bar code labels for finished goods

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VISHAY SEMICONDUCTOR GmbH STANDARD BAR CODE PRODUCT LABEL (finished goods)		
PLAIN WRITING	ABBREVIATION	LENGTH
Item-description	-	18
Item-number	INO	8
Selection-code	SEL	3
LOT-/serial-number	BATCH	10
Data-code	COD	3 (YWW)
Plant-code	PTC	2
Quantity	QTY	8
Accepted by	ACC	-
Packed by	PCK	-
Mixed code indicator	MIXED CODE	-
Origin	xxxxxxx+	Company logo
LONG BAR CODE TOP	TYPE	LENGTH
Item-number	N	8
Plant-code	N	2
Sequence-number	X	3
Quantity	N	8
Total length	-	21
SHORT BAR CODE TOP	TYPE	LENGTH
Selection-code	X	3
Data-code	N	3
Batch-number	X	10
Filter	-	1
Total length	-	17

DRY PACKAGING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



15973

RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 72 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

- 192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air/nitrogen) or
- 96 h at 60 °C + 5 °C and < 5 % RH for all device containers or
- 24 h at 125 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC® standard JSTD-020 level 4 label is included on all dry bags.



22522

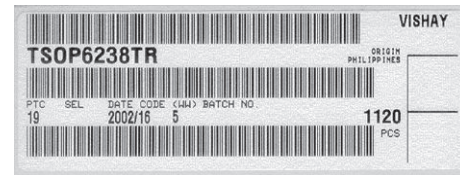
EIA JEDEC standard JSTD-020 level 4 label is included on all dry bags

ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

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16962

OUTER PACKAGING

The sealed reel is packed into a pizza box.

CARTON BOX DIMENSIONS in millimeters			
	THICKNESS	WIDTH	LENGTH
Pizza Box (SMD and Heimdall) (Taping in Reels)	50	340	340

22127



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С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

- Конкурентоспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



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